DECLARATION FOR PATENT APPLICATION

Docket:

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

Abdichtung für medienführende Teile

the specification of which (check one)

<u> </u>	is attached hereto.	
	was filed on	_ as
	Application Serial No.	and
	was amended on(i	f applicable).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amonded by any amondment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations Section 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code 119 of any foreign application(s) for patent or inventor's cortificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign	Application(B)		Priority Claimed
10022515.2	Germany	10/05/2000	Yes No
(Number)	(Country)	(Day/Month/Year Filed)	
			Yes No
(Number)	(Country)	(Day/Month/Year Filed)	•
			Yes No
(Number)	(Country)	(Day/Month/Year Filed)	

I hereby claim the benefit under Title 35, United States Code, Section 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Section 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Appln. Serial No.)	(Filing Date)	(Status-patent, ponding, abandoned)
("ppin: Serial NO.)	(FIIIng Date)	(scatus-patent, ponuting, abandoned)
(Appln. Serial No.)	(Filing Date)	(Status-patent, pending, abandoned)
	· .	
(Appln. Serial No.)	(Filing Date)	(Status-patent, pending, abandoned)

I horeby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the Unit d States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint J. Rodman Steele, Jr., Registration No. 25,931; Gregory A. Nelson, Registration No. 30,577; and Joseph W. Bain, Registration No. 34,290 as my attorneys with full power of substitution and revocation to prosecute this application and to transact all business in the Patent and Trademark Office connected thorewith, to amend the specification, to appeal in case of rejection, as they may deem advisable, to receive the patent when granted and generally to do all matters and things needful in the premises as fully and to all intents and purposes as I could do.

Please direct all correspondence to:

	U 100m		
Full name of sole or first invento	r Harry JUST		
Inventor's signature	Date		
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	Germany		
Pull name of second loint inventor	r, if any		
Second Inventor's signature	Date		
Desidence			
Citizenship			
Post Office Address			
Full name of third joint inventor, Second Inventor's signature	, if any Date		
Post Office Address			
Full name of fourth joint inventor	r, if any		
Second Inventor's signature	Date		
Residence			
Citizenship			
Post Office Address			
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